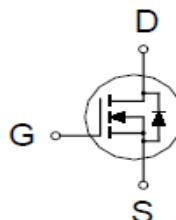
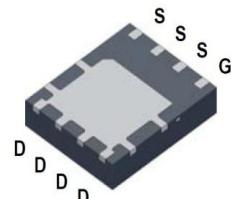


# PK608BA

## N-Channel Enhancement Mode MOSFET

### PRODUCT SUMMARY

$V_{(BR)DSS}$	$R_{DS(ON)}$	$I_D$
40V	3.5mΩ @ $V_{GS} = 10V$	87A



**PDFN 5X6P**

### ABSOLUTE MAXIMUM RATINGS ( $T_A = 25^\circ C$ Unless Otherwise Noted)

PARAMETERS/TEST CONDITIONS	SYMBOL	LIMITS	UNITS
Drain-Source Voltage	$V_{DS}$	40	V
Gate-Source Voltage	$V_{GS}$	$\pm 20$	V
Continuous Drain Current <sup>2</sup>	$I_D$	87	A
		55	
Pulsed Drain Current <sup>1</sup>	$I_{DM}$	150	A
Continuous Drain Current	$I_D$	20	
		15.6	
Avalanche Current	$I_{AS}$	49	
Avalanche Energy	$E_{AS}$	120	mJ
Power Dissipation	$P_D$	50	W
		20	
Power Dissipation	$P_D$	2.4	W
		1.5	
Operating Junction & Storage Temperature Range	$T_J, T_{stg}$	-55 to 150	°C

### THERMAL RESISTANCE RATINGS

THERMAL RESISTANCE	SYMBOL	TYPICAL	MAXIMUM	UNITS
Junction-to-Ambient <sup>3</sup>	$R_{\theta JA}$		50.2	°C / W
Junction-to-Case	$R_{\theta JC}$		2.5	

<sup>1</sup>Pulse width limited by maximum junction temperature.

<sup>2</sup>Package limitation current is 51A.

<sup>3</sup>The value of  $R_{\theta JA}$  is measured with the device mounted on 1in<sup>2</sup> FR-4 board with 2oz. Copper, in a still air environment with  $T_A = 25^\circ C$ .

## PK608BA

### N-Channel Enhancement Mode MOSFET

#### ELECTRICAL CHARACTERISTICS ( $T_J = 25^\circ\text{C}$ , Unless Otherwise Noted)

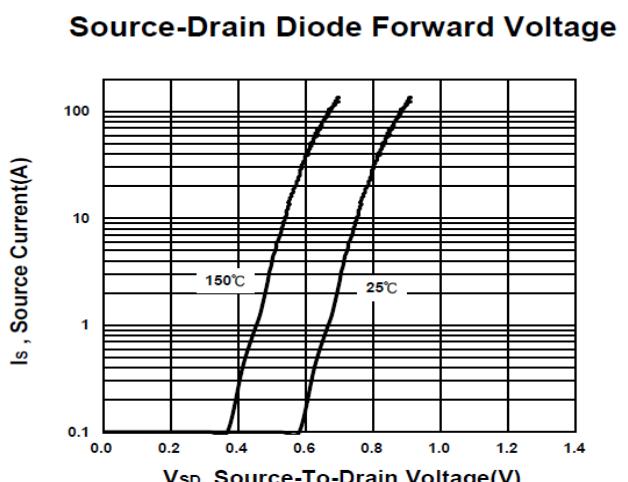
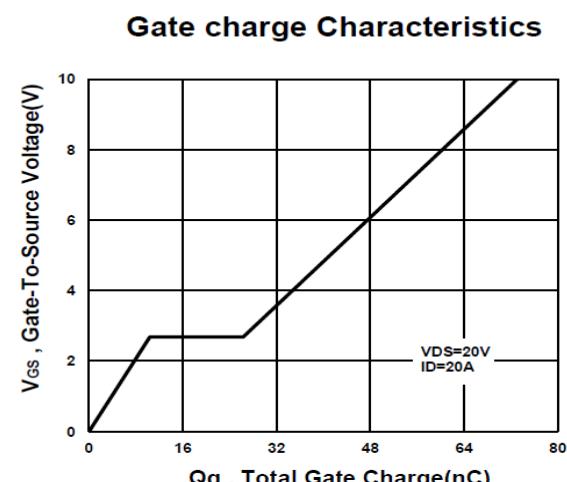
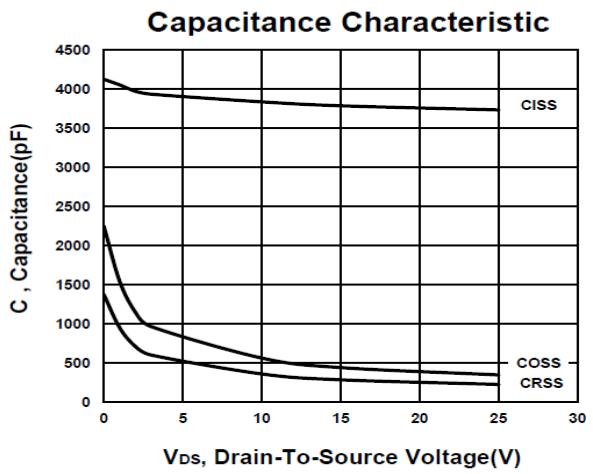
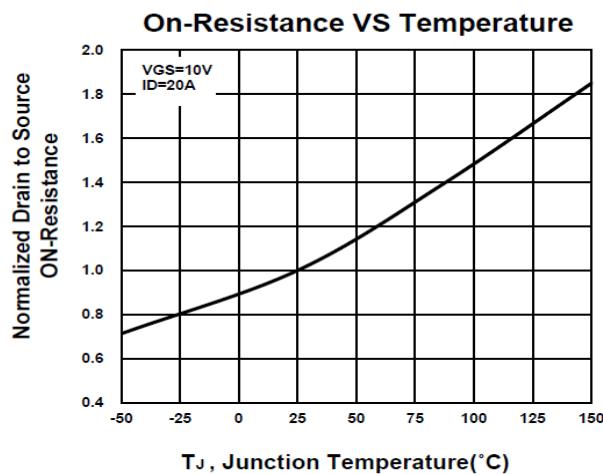
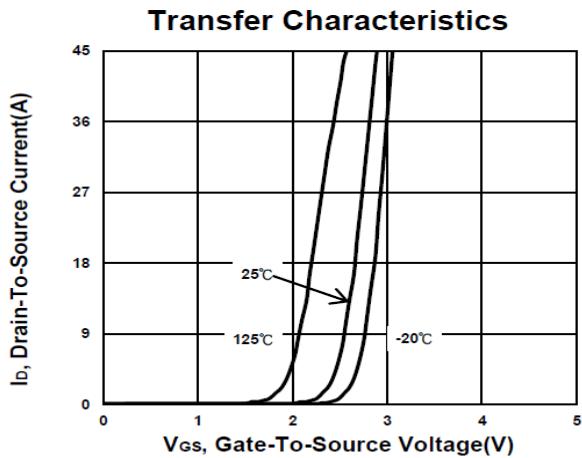
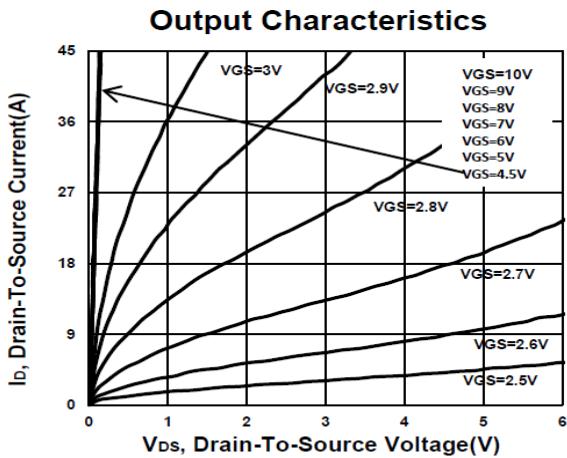
PARAMETER	SYMBOL	TEST CONDITIONS	LIMITS			UNITS
			MIN	TYP	MAX	
<b>STATIC</b>						
Drain-Source Breakdown Voltage	$V_{(\text{BR})\text{DSS}}$	$V_{\text{GS}} = 0\text{V}, I_D = 250\mu\text{A}$	40			V
Gate Threshold Voltage	$V_{\text{GS}(\text{th})}$	$V_{\text{DS}} = V_{\text{GS}}, I_D = 250\mu\text{A}$	1.3	1.75	2.3	
Gate-Body Leakage	$I_{\text{GSS}}$	$V_{\text{DS}} = 0\text{V}, V_{\text{GS}} = \pm 20\text{V}$			$\pm 100$	nA
Zero Gate Voltage Drain Current	$I_{\text{DSS}}$	$V_{\text{DS}} = 40\text{V}, V_{\text{GS}} = 0\text{V}$			1	$\mu\text{A}$
		$V_{\text{DS}} = 32\text{V}, V_{\text{GS}} = 0\text{V}, T_J = 55^\circ\text{C}$			10	
Drain-Source On-State Resistance <sup>1</sup>	$R_{\text{DS}(\text{ON})}$	$V_{\text{GS}} = 4.5\text{V}, I_D = 15\text{A}$		3	4.6	$\text{m}\Omega$
		$V_{\text{GS}} = 10\text{V}, I_D = 20\text{A}$		2.6	3.5	
Forward Transconductance <sup>1</sup>	$g_{\text{fs}}$	$V_{\text{DS}} = 5\text{V}, I_D = 20\text{A}$		136		S
<b>DYNAMIC</b>						
Input Capacitance	$C_{\text{iss}}$	$V_{\text{GS}} = 0\text{V}, V_{\text{DS}} = 20\text{V}, f = 1\text{MHz}$		3884		pF
Output Capacitance	$C_{\text{oss}}$			441		
Reverse Transfer Capacitance	$C_{\text{rss}}$			329		
Gate Resistance	$R_g$	$V_{\text{GS}} = 0\text{V}, V_{\text{DS}} = 0\text{V}, f = 1\text{MHz}$		1.1		$\Omega$
Total Gate Charge <sup>2</sup>	$Q_g$	$V_{\text{GS}} = 10\text{V}$ $V_{\text{GS}} = 4.5\text{V}$		77		nC
				40		
Gate-Source Charge <sup>2</sup>	$Q_{\text{gs}}$	$V_{\text{GS}} = 10\text{V}, I_D = 20\text{A}$		11		
Gate-Drain Charge <sup>2</sup>	$Q_{\text{gd}}$			19		
Turn-On Delay Time <sup>2</sup>	$t_{\text{d}(\text{on})}$	$V_{\text{DS}} = 20\text{V}$ , $V_{\text{GS}} = 10\text{V}, I_D = 20\text{A}$ $I_D \geq 20\text{A}, V_{\text{GS}} = 10\text{V}, R_{\text{GEN}} = 6\Omega$		25		nS
Rise Time <sup>2</sup>	$t_r$			18		
Turn-Off Delay Time <sup>2</sup>	$t_{\text{d}(\text{off})}$			65		
Fall Time <sup>2</sup>	$t_f$			18		
<b>SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS (<math>T_J = 25^\circ\text{C}</math>)</b>						
Continuous Current	$I_S$	$I_F = 20\text{A}, V_{\text{GS}} = 0\text{V}$			38	A
Forward Voltage <sup>1</sup>	$V_{\text{SD}}$				1.3	V
Reverse Recovery Time	$t_{\text{rr}}$			25		nS
Reverse Recovery Charge	$Q_{\text{rr}}$			19		nC

<sup>1</sup>Pulse test : Pulse Width  $\leq 300\text{ }\mu\text{sec}$ , Duty Cycle  $\leq 2\%$ .

<sup>2</sup>Independent of operating temperature.

## PK608BA

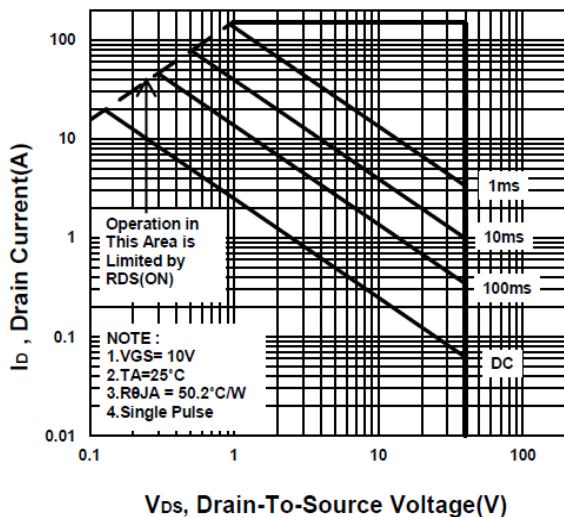
### N-Channel Enhancement Mode MOSFET



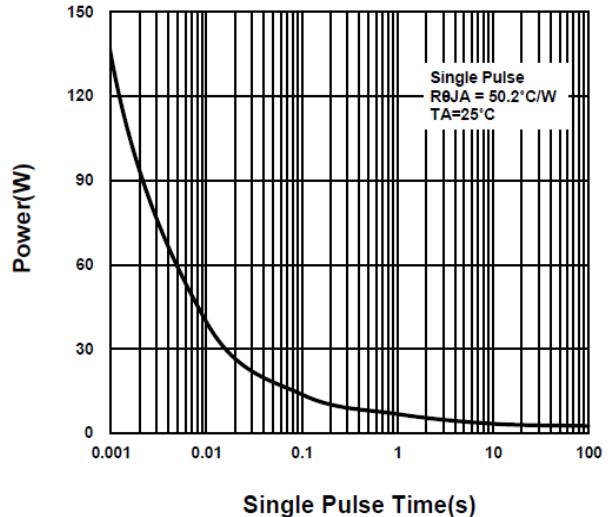
## PK608BA

### N-Channel Enhancement Mode MOSFET

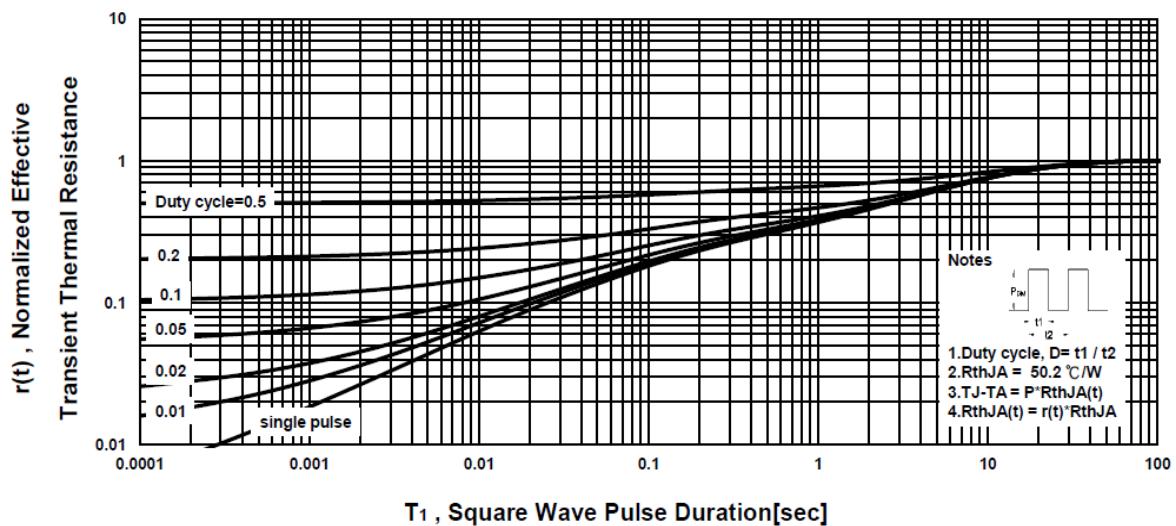
**Safe Operating Area**



**Single Pulse Maximum Power Dissipation**



**Transient Thermal Response Curve**

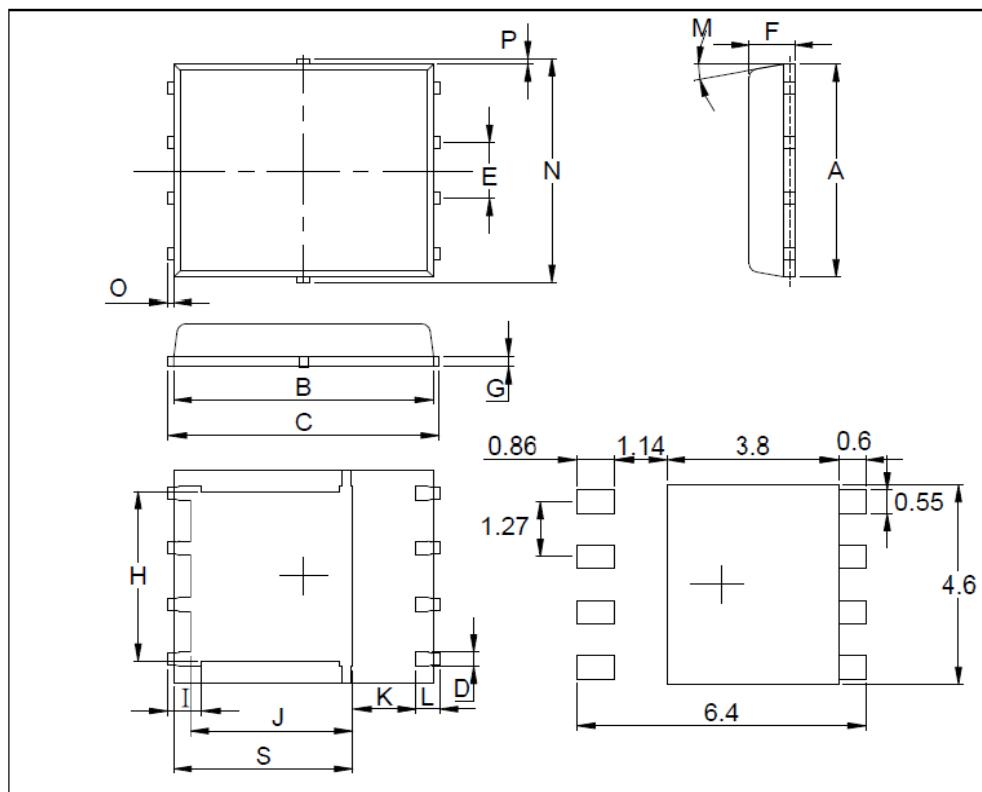


## PK608BA

### N-Channel Enhancement Mode MOSFET

#### PDFN 5x6P MECHANICAL DATA

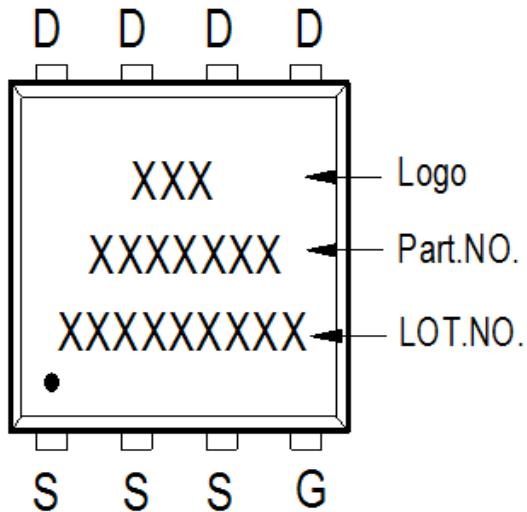
Dimension	mm			Dimension	mm		
	Min.	Typ.	Max.		Min.	Typ.	Max.
A	4.8		5.15	J	3.33		3.78
B	5.44		5.9	K	0.9		
C	5.9		6.35	L	0.35		0.712
D	0.33		0.51	M	0°		12°
E		1.27		N	4.8		5.5
F	0.8		1.25	O	0.05		0.3
G	0.15		0.34	P	0.06		0.2
H	3.61		4.31	S	3.69		4.19
I	0.35		0.71				



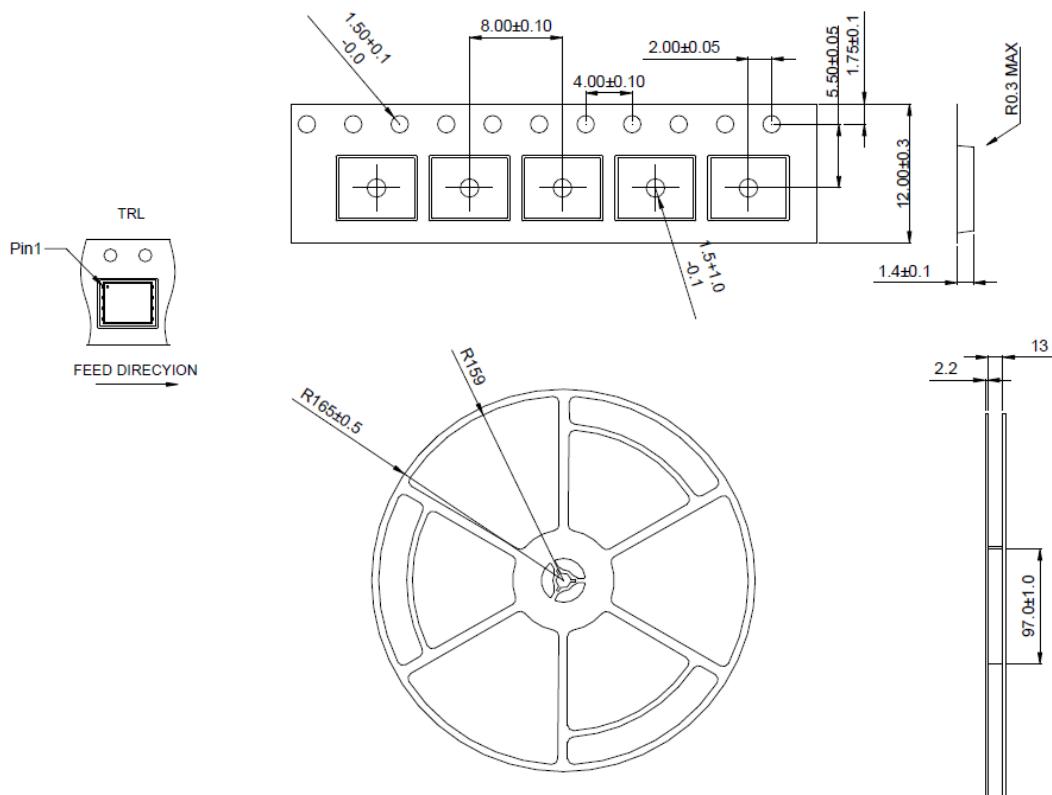
## PK608BA

### N-Channel Enhancement Mode MOSFET

#### A. Marking Information



#### B. Tape&Reel Information: 3000pcs/Reel

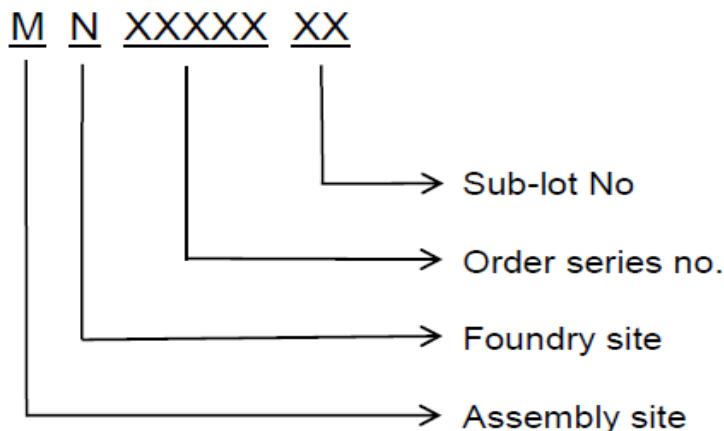


## **PK608BA**

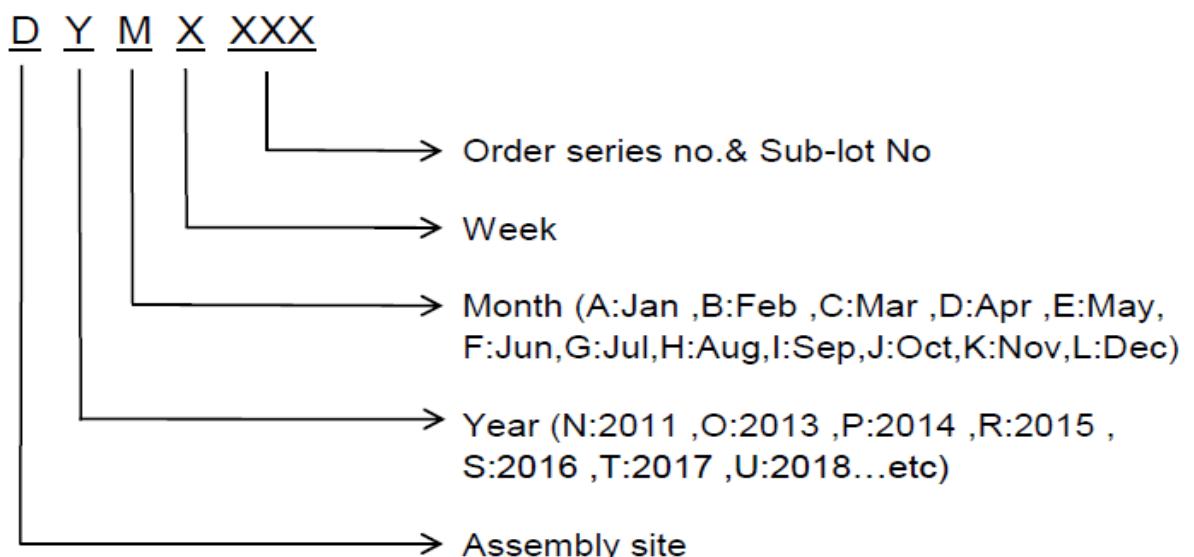
### **N-Channel Enhancement Mode MOSFET**

#### **C. Lot No.&Date Code rule**

##### **1. Lot No.**



##### **2. Date Code**



## PK608BA N-Channel Enhancement Mode MOSFET

### D.Label rule

标签内容(Label content)



1	Label Size	30 * 90 mm		
2	Font style	Times New Roman or Arial (或可区分英文“0”和数字“0”，“G”和“Q”的字型即可)		
3	U-NIKC	Height: 4 mm		
4	Package	Height: 2 mm		
5	Date	Height: 2 mm Shipping date: YYYY/MM/DD, ex. 2008/09/12		
6	Device	Height: 3 mm (Max: 16 Digit)		
7	Lot	Height: 3 mm (Max: 9 Digit) Sub lot		
8	D/C	Height: 3 mm (Max: 7 Digit)		
9	QTY	Height: 3 mm (Max: 6 Digit) Thousand mark is no needed		
10	RoHS label		long axis: 12 mm bottom color: White Font color: Black	minor axis: 6 mm Font style: Arial
11	Halogen Free label		Diameter: 10 mm Font color: Black	bottom color: Green Font style: Arial
12	Scan information	Device / Lot / D/C / QTY , Insert “ / ” between every parts. for example: P3055LDG/G12345601/GGG2301/2000 DPI (Dots per inch): Over 300 dpi Code : Code 128 Height: 6 mm at least		